

FTK2310 N-Channel MOSFET

DESCRIPTION

The FTK2310 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltage as low as 2.5V. This device is suitable for use as a battery protection or in other switching application.

FEATURES

- High power and current handing capability
- Lead free product is acquired
- Surface mount package

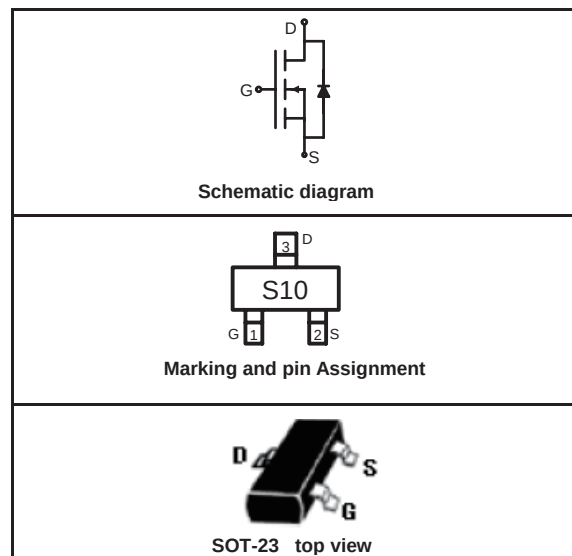
APPLICATION

- Battery Switch
- DC/DC Converter

MARKING: S10

Maximum ratings ($T_a=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	60	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current	I_D	3	A
Pulsed Drain Current (note 1)	I_{DM}	10	A
Power Dissipation	P_D	0.35	W
Thermal Resistance from Junction to Ambient (note 2)	$R_{\theta JA}$	357	$^{\circ}\text{C/W}$
Junction Temperature	T_J	150	$^{\circ}\text{C}$
Storage Temperature	T_{STG}	-55~+150	$^{\circ}\text{C}$



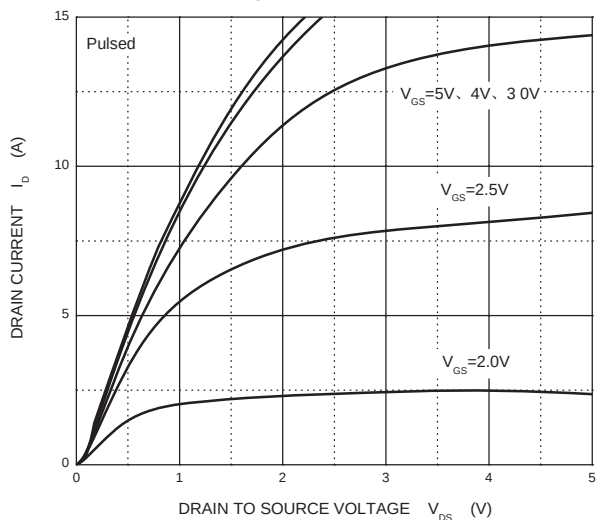
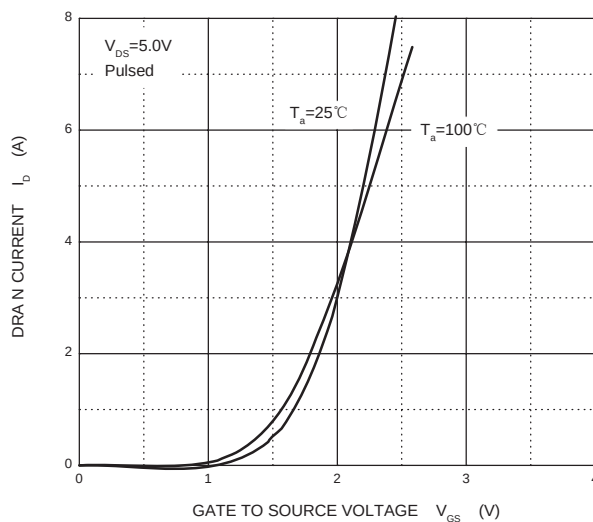
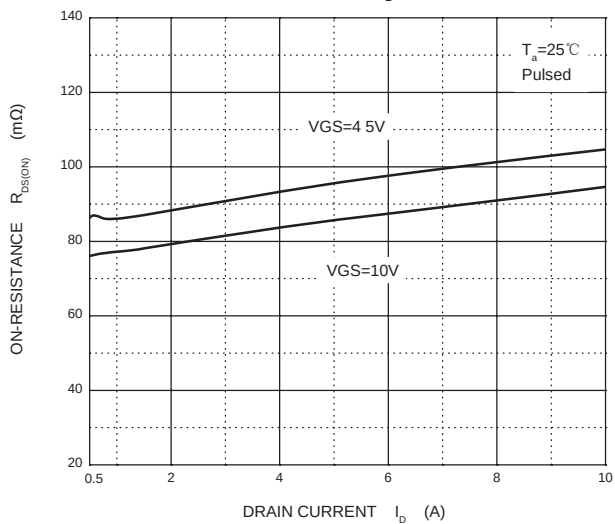
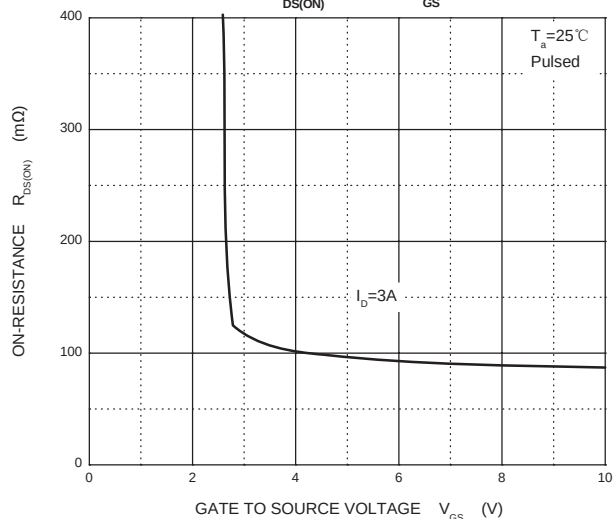
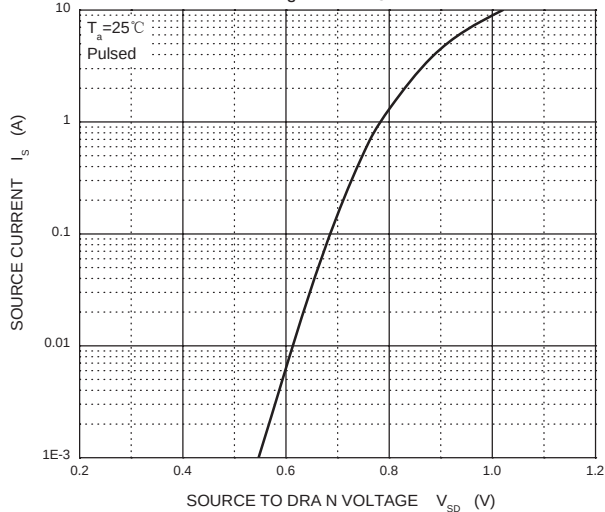
Electrical characteristics (T_a=25°C unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
STATIC CHARACTERISTICS						
Drain-source breakdown voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D =250μA	60			V
Zero gate voltage drain current	I _{DSS}	V _{DS} =60V, V _{GS} = 0V			1	μA
Gate-body leakage current	I _{GSS}	V _{GS} =±20V, V _{DS} = 0V			±100	nA
Gate threshold voltage (note 3)	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	0.5		2	V
Drain-source on-resistance (note 3)	R _{DS(on)}	V _{GS} =10V, I _D =3A			105	mΩ
		V _{GS} =4.5V, I _D =3A			125	mΩ
Forward tranconductance (note 3)	g _{FS}	V _{DS} =15V, I _D =2A	1.4			S
Diode forward voltage (note 3)	V _{SD}	I _S =3A, V _{GS} = 0V			1.2	V
DYNAMIC CHARACTERISTICS (note 4)						
Input Capacitance	C _{iSS}	V _{DS} =30V, V _{GS} =0V, f =1MHz		247		pF
Output Capacitance	C _{oSS}			34		pF
Reverse Transfer Capacitance	C _{rSS}			19.5		pF
SWITCHING CHARACTERISTICS (note 4)						
Turn-on delay time	t _{d(on)}	V _{GS} =10V, V _{DD} =30V, I _D =1.5A, R _{GEN} =1Ω		6		ns
Turn-on rise time	t _r			15		ns
Turn-off delay time	t _{d(off)}			15		ns
Turn-off fall time	t _f			10		ns
Total Gate Charge	Q _g	V _{DS} =30V, V _{GS} =4.5V, I _D =3A		6		nC
Gate-Source Charge	Q _{gs}			1		nC
Gate-Drain Charge	Q _{gd}			1.3		nC

Notes :

1. Repetitive rating : Pulse width limited by junction temperature.
2. Surface mounted on FR4 board , t_s ≤ 10s.
3. Pulse Test : Pulse Width ≤ 300μs, Duty Cycle ≤ 0.5%.
4. Guaranteed by design, not subject to producing.

Typical Characteristics

Output Characteristics

Transfer Characteristics

 $R_{DS(ON)}$ — I_D

 $R_{DS(ON)}$ — V_{GS}

 I_S — V_{SD}

Threshold Voltage
